

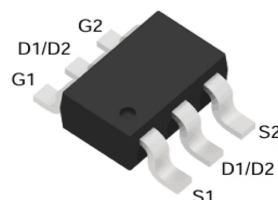
Features

Low Gate Charge
100% UIS Tested, 100% DVDS Tested
High Power and current handing capability
Lead free product is acquired

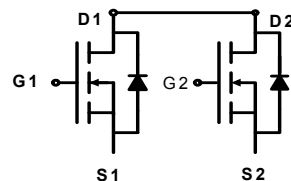
V_{DS} 20 V
 I_D 6 A
 $R_{DS(ON)}$ 20 m Ω

8205

SOT 23-6L



Equivalent Circuit



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings (@ $T_a = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Limit	Unit
V_{DS}	Drain-Source Voltage ($V_{GS}=0V$)	20	V
V_{GS}	Gate-Source Voltage ($V_{DS}=0V$)	± 12	V
I_D	Drain Current-Continuous($T_A=25^\circ\text{C}$)	6	A
	Drain Current-Continuous($T_A=100^\circ\text{C}$)	4.3	A
I_{DM} (pluse)	Drain Current-Continuous@ Current-Pulsed (Note 1)	27.2	A
P_D	Maximum Power Dissipation($T_A=25^\circ\text{C}$)	1.3	W
	Maximum Power Dissipation($T_A=100^\circ\text{C}$)	0.53	W
E_{AS}	Avalanche energy (Note 2)	25	mJ
T_J, T_{STG}	Operating Junction and Storage Temperature Range	-55 To 150	$^\circ\text{C}$

Thermal Characteristic

Symbol	Parameter	Typ	Max	Unit
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		95	$^\circ\text{C/W}$

RATING AND CHARACTERISTIC CURVES

Figure 1. Output Characteristics

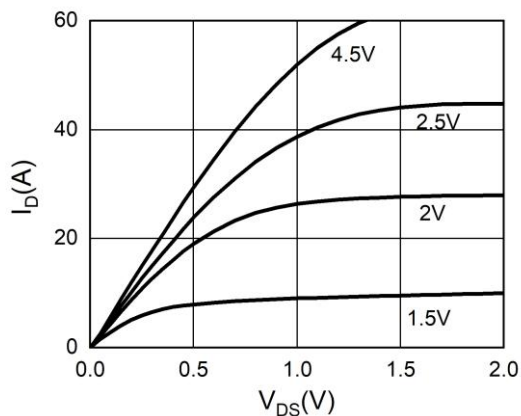


Figure 2. Transfer Characteristics

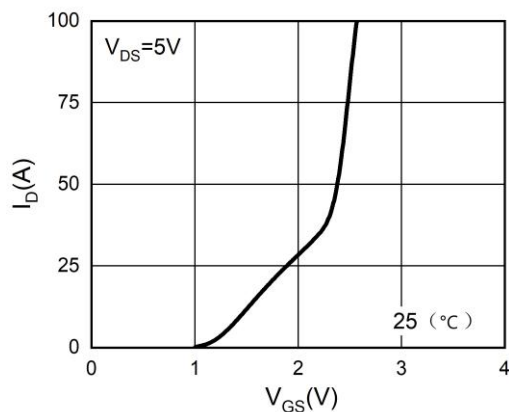


Figure 3. Power Dissipation

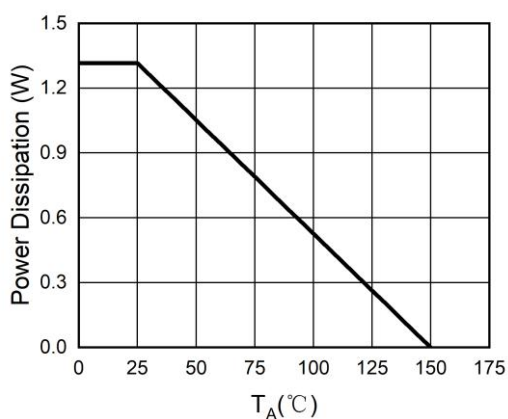


Figure 4. Drain Current

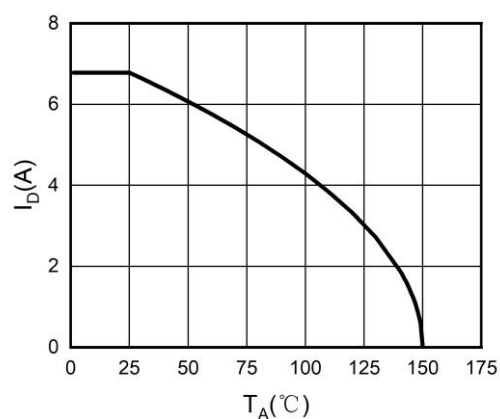


Figure 5. BV_{DSS} vs Junction Temperature

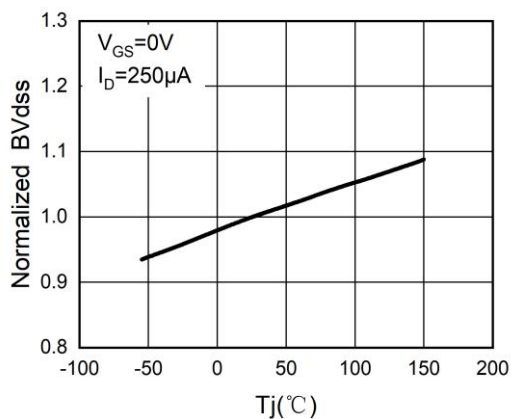
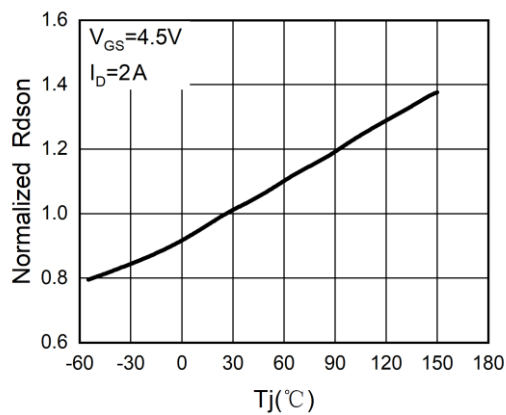


Figure 6. $R_{DS(ON)}$ vs Junction Temperature



RATING AND CHARACTERISTIC CURVES

Figure 7. Gate Charge Waveforms

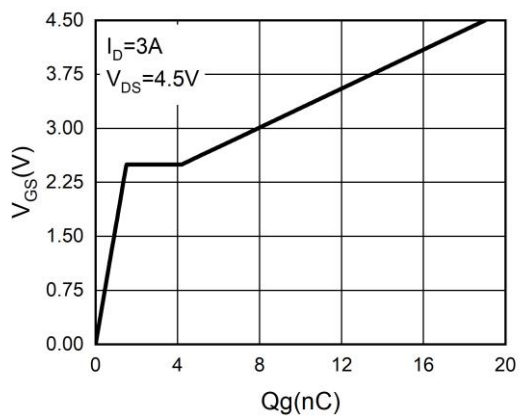


Figure 8. Capacitance

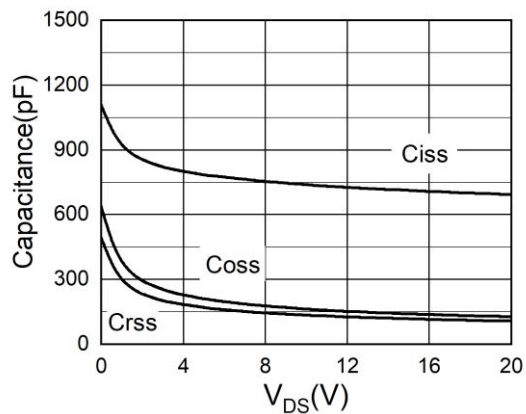


Figure 9. Body-Diode Characteristics

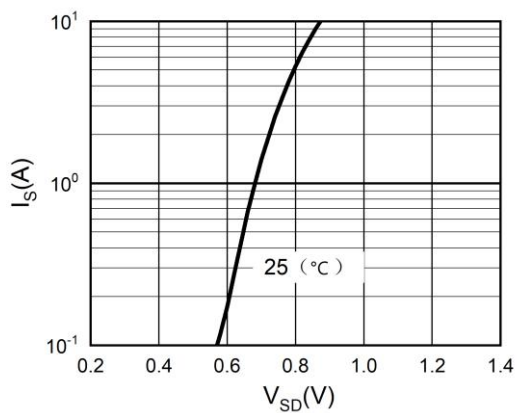
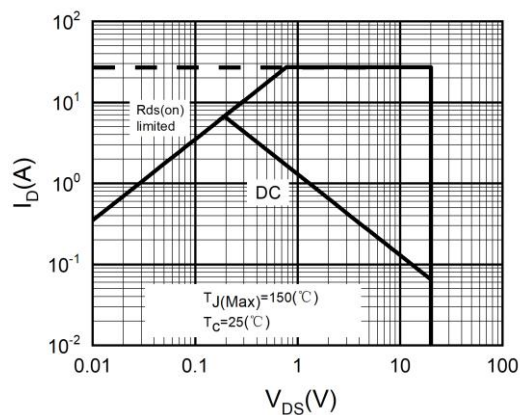
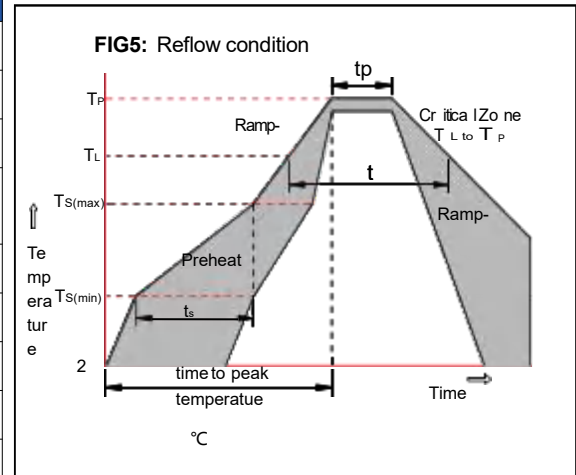


Figure 10. Maximum Safe Operating Area



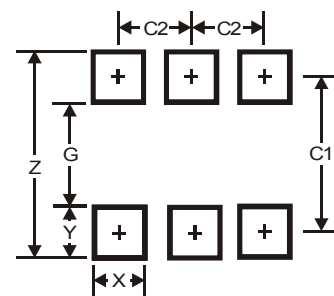
Soldering parameters

Reflow Condition		Pb-Free assembly (see as below)
Pre Heat	-Temperature Min ($T_{s(min)}$)	+150 °C
	-Temperature Max($T_{s(max)}$)	+200 °C
	-Time (Min to Max) (ts)	60-180 secs.
Average ramp up rate (Liquid us Temp (T_L) to peak)		3 °C/sec. Max
$T_{s(max)}$ to T_L - Ramp-up Rate		3 °C/sec. Max
Reflow	-Temperature(T_L)(Liquid us)	+217 °C
	-Temperature(t_L)	60-150 secs.
Peak Temp (T_P)		+260(+0/-5) °C
Time within 5 °C of actual Peak Temp (t_P)		30 secs. Max
Ramp-down Rate		6 °C/sec. Max
Time 25 °C to Peak Temp (T_P)		8 min. Max
Do not exceed		+260 °C



Package Dimensions & Suggested Pad Layout

SOT23-6L



Dimensions	Value (in mm)
Z	3.50
G	1.30
X	0.65
Y	1.10
C1	2.40
C2	0.95

Dimensions in millimeters

